

L Number	Hits	Search Text	DB	Time stamp
1	49662	transparent adj substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 10:54
2	3	4010355.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 10:39
3	55	235/462.05.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 10:48
4	1	235/462.05.ccls. and (transparent adj portion)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 10:50
6	2	235/462.05.ccls. and ((transparent adj substrate) and barcode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 10:51
5	77	(transparent adj substrate) and barcode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 10:53
7	11	((transparent adj substrate) and barcode) and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 10:53
8	2	(transparent adj substrate) same barcode same wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 10:55
9	982	(transparent adj substrate) same wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 10:55
11	0	((transparent adj portion) same substrate same wafer) and 235/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 10:55

10	88	(transparent adj portion) same substrate same wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 11:01
13	0	((transparent adj portion) same wafer) and 235/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 11:02
14	0	((transparent adj portion) same wafer) and barcode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 11:02
12	241	(transparent adj portion) same wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 11:03
15	0	(transparent adj portion) adj of adj wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 12:37
16	2	6460770.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 12:40
17	106711	semiconductor adj wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 12:40
18	7425	(semiconductor adj wafer) and transparent	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 12:40
19	209	((semiconductor adj wafer) and transparent) and (transparent adj portion)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 12:40
20	0	((semiconductor adj wafer) and transparent) and (transparent adj portion)) and barcode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 12:40

21	25	((semiconductor adj wafer) and transparent) and (transparent adj portion) and (bar adj code)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 13:06
22	154	235/472.02.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/03 13:07
-	348	235/487.ccls. and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 19:40
-	1	(235/487.ccls. and substrate) and (reticle or reticule)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 15:08
-	0	20020020751.URPN.	USPAT	2003/03/19 19:41
-	1468382	substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 19:41
-	7833	substrate and (reticle or reticule)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 19:41
-	101	((substrate and (reticle or reticule)) and transfer) and (barcode or bar adj code)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 20:08
-	34	("3823318" "4519692" "4676630" "4711568" "4748477" "4749867" "4804978" "4822975" "4884101" "4947047" "4970546" "4974919" "4998134" "5053614" "5107275" "5112133" "5119390" "5171965" "5182615" "5191374" "5250797" "5473412" "5475491" "5491534" "5608492" "5617182" "5627627" "5663784" "5728495" "5777724" "5846678" "6078381" "6081319" "6175405").PN.	USPAT	2003/03/19 19:47
-	0	6424405.URPN.	USPAT	2003/03/19 19:50
-	0	6424405.URPN.	USPAT	2003/03/19 19:50

-	82090	matsumoto.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 20:47
-	676	matsumoto.in. and ken	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 20:47
-	6	(matsumoto.in. and ken) and 235/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 20:47
-	3	((matsumoto.in. and ken) and 235/\$.ccls.) and reticle	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 20:47
-	7	("4105926" "4782219" "4856857" "5053612" "5636004" "5929997" "6024455").PN.	USPAT	2003/03/19 20:48
-	0	6445450.URPN.	USPAT	2003/03/19 20:48
-	0	6445450.URPN.	USPAT	2003/03/19 20:49
-	6	6048655.pn. 4999671.pn. 4716299.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:19
-	0	(6048655.pn. 4999671.pn. 4716299.pn.) and internet	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 10:40
-	0	(6048655.pn. 4999671.pn. 4716299.pn.) and network	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 10:40
-	10	430/22.ccls. and internet	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 10:43
-	34	430/22.ccls. and network	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 10:47

-	5	(substrate adj transfer adj apparatus) and (barcode or bar adj code)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT	2003/03/25 17:52
-	37	("3968885" "4529353" "4539695" "4643629" "4695215" "4752898" "4758127" "4760429" "4770590" "4778331" "4787800" "4818169" "4824309" "4907931" "4917556" "4984953" "4985722" "4995063" "4999671" "5026239" "5059079" "5061144" "5102280" "5135349" "5183370" "5217340" "5301013" "5308222" "5364222" "5404894" "5405230" "5464715" "5471279" "5498118" "5509771" "5909030" "6085125").PN.		2003/03/23 10:50
-	0	6473157.URPN.	USPAT	2003/03/23 10:51
-	0	6473157.URPN.	USPAT	2003/03/23 10:51
-	0	20020020751.URPN.	USPAT	2003/03/23 10:51
-	0	2002050667.URPN.	USPAT	2003/03/23 10:51
-	1	2002-338446.NRAN.	DERWENT	2003/03/23 10:51
-	0	((("3968885" "4529353" "4539695" "4643629" "4695215" "4752898" "4758127" "4760429" "4770590" "4778331" "4787800" "4818169" "4824309" "4907931" "4917556" "4984953" "4985722" "4995063" "4999671" "5026239" "5059079" "5061144" "5102280" "5135349" "5183370" "5217340" "5301013" "5308222" "5364222" "5404894" "5405230" "5464715" "5471279" "5498118" "5509771" "5909030" "6085125").PN.) and internet	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 10:51

-	0	(("3968885" "4529353" "4539695" "4643629" "4695215" "4752898" "4758127" "4760429" "4770590" "4778331" "4787800" "4818169" "4824309" "4907931" "4917556" "4984953" "4985722" "4995063" "4999671" "5026239" "5059079" "5061144" "5102280" "5135349" "5183370" "5217340" "5301013" "5308222" "5364222" "5404894" "5405230" "5464715" "5471279" "5498118" "5509771" "5909030" "6085125").PN.) and network	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 10:51
-	2	6493065.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 10:52
-	9	("4669883" "4834540" "4861162" "4886974" "5659384" "5835227" "6064486" "6151120" "6323952").PN.	USPAT	2003/03/23 10:52
-	0	6493065.URPN.	USPAT	2003/03/23 10:53
-	9	6051843.pn. 5978071.pn. 5461237.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 11:03
-	2335	235/487.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:03
-	0	(6048655.pn. 4999671.pn. 4716299.pn.) and lan	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:03
-	0	(6048655.pn. 4999671.pn. 4716299.pn.) and (local adj area adj network)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:03
-	77520	atm	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:04
-	3959	atm and (local adj area adj network)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:04

-	3274	(atm and (local adj area adj network)) and LAN	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:04
-	41	((atm and (local adj area adj network)) and LAN) and 235/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:06
-	8	((atm and (local adj area adj network)) and LAN) and 235/\$.ccls.) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:09
-	7	plurality same atm same terminal same networked	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:10
-	1	(plurality same atm same terminal same networked) and LAN	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:10
-	2	5822524.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:22
-	2	5929978.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/23 12:22
-	2414	235/487.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 15:08
-	1	(235/487.ccls. and substrate) and (reticle or reticule)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 15:09
-	0	6597969.pn. 4010355.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 15:09

-	4	6597969.pn. 4010355.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 15:10
-	1677	(conveying or conveyor) same scan\$4 same (indicia or code or barcode\$1 or label or symbol)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 15:11
-	517	((conveying or conveyor) same scan\$4 same (indicia or code or barcode\$1 or label or symbol)) and 235/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 15:11
-	395	(conveying or conveyor) same scan\$4 same (indicia or code or barcode\$1 or label or symbol) same (moving or transporting)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 15:11
-	0	(conveying or conveyor) same scan\$4 same (barcode\$1) same (wafer\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 15:12
-	64	(conveying or conveyor) same scan\$4 same (wafer\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 15:12
-	3	(conveying or conveyor) same scan\$4 same (wafer\$1) same code\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 17:23
-	157	355/97.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 19:17
-	12948130	250/571.ccls. n	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 19:22
-	8	semiconductor same exposure same barcode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 17:23
-	4	("4833306" "6303398" "6446022" "6507765").PN.	USPAT	2003/09/11 19:29

-	0	6618640.URPN.	USPAT	2003/09/11 19:30
-	0	(semiconductor same exposure same barcode) and (("4833306" "6303398" "6446022" "6507765").PN.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 19:30
-	0	((("4833306" "6303398" "6446022" "6507765").PN.) and exposure) and barcode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 19:30
-	1	((("4833306" "6303398" "6446022" "6507765").PN.) and exposure	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/11 19:31
-	2489	235/487.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 17:22
-	3808	(substrate and (reticle or reticule)) and transfer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 17:22
-	0	250/571.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 17:23
-	3	(conveying or conveyor) same scan\$4 same (wafer\$1) same code\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 17:23
-	3	(conveying or conveyor) same scan\$4 same (wafer\$1) same code\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 17:23
-	9	semiconductor same exposure same barcode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 17:48
-	2	6,618,640	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 18:01

-	4	("4833306" "6303398" "6446022" "6507765").PN.	USPAT	2004/04/16 17:49
-	3	4010355.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 18:01
-	2	5864130.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 21:54
-	2553	235/487.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 21:59
-	1704	430/22.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 22:05
-	158	355/97.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 21:59
-	221	substrate adj transfer adj apparatus	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 21:59
-	748	235/462.01.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 22:08
-	2	6739513.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 22:08
-	6	6705523.pn. 5914474.pn. 6739513.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 22:08